TOSHIBA Photocoupler GaAs Ired & Photo-Transistor

TLP628,TLP628-2,TLP628-4

Programmable Controllers Unit in mm DC-Output Module TLP628 **Telecommunication** The TOSHIBA TLP628, -2, and -4 consists of a gallium arsenide infrared emitting diode optically coupled to a phototransistor which has a 350V high voltage of collector-emitter breakdown voltage. The TLP628-2 offers two isolated channels in a eight lead plastic DIP package, while the TLP628-4 provide four isolated channels per package. **TOSHIBA** 11-5B2 Collector-emitter voltage: 350 V (min.) Weight: 0.26 g (typ.) Current transfer ratio: 50% (min.) Isolation voltage: 5000Vrms (min.) UL recognized: UL1577, file No. E67349 TLP628-2 BSI approved: BS EN60065:2002, certificate no.7426 BS EN60950-1:2002, certificate no.7427 Pin Configurations (top view) TLP628-4 TLP628-2 TLP628 2 **1**15 **TOSHIBA** 11-10C4 1: Anode Weight: 0.54 g (typ.) 3 2. Cathode 3. Emitter 4: Collector 41 TLP628-4 ∕5 **୮ T**12 2, 4: Cathode 5. 7: Emitter 6, 8: Collector 6 **[** 7 🗀 8

11-20A3

1, 3, 5, 7: Anode

2, 4, 6, 8: Cathode 9, 11, 13, 15: Emitter

10, 12, 14, 16: Collector

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Weight: 1.1 g (typ.)



Absolute Maximum Ratings (Ta = 25°C)

Characteristic			Ra			
		Symbol	TLP628	TLP628-2 TLP628-4	Unit	
	Forward current	lF	60 50		mA	
	Forward current derating	ΔI _F / °C	–0.7 (Ta ≥ 39°C)	–0.5 (Ta ≥ 25°C)	mA / °C	
LED	Pulse forward current	I _{FP}	1 (100µs pu	1 (100µs pulse, 100pps)		
	Reverse voltage	V_{R}	!	5 (V	
	Junction temperature	Tj	12	25	Ç	
	Collector-emitter voltage	V_{CEO}	35	50	⟨ ∨	
	Emitter-collector voltage	V _{ECO}	-	/ v		
tor	Collector current	IC	50		mA	
Detector	Collector power dissipation (1 circuit)	PC	150	150 100		
	Collector power dissipation derating (Ta ≥ 25°C, 1 circuit)	ΔP _C / °C	-1.5	-1.0	mW/°C	
	Junction temperature	Tj	125		Ĉ	
Stor	rage temperature range	T _{stg}	-55:			
Оре	erating temperature range	T _{opr}	-55·)°E		
Lead soldering temperature		T _{sol}	260 (10s)		Ç	
Total package power dissipation (1 circuit)		PT	200	150	mW	
Total package power dissipation derating (Ta ≥ 25°C, 1 circuit)		ΔP _T / °C	-2.0	-1.5	mW / °C	
Isolation voltage		BVS	5000 (AC, 1mii	n., R.H. ≤ 60%) (Note 1)	Vrms	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

(Note 1) Device considered a two terminal device: LED side pins shorted together and detector side pins shorted together.

Recommended Operating Conditions

Characteristic	Symbol	Min.	Тур.	Max.	Unit
Supply voltage	V _{CC}	_	_	200	V
Forward current) I _F	_	16	25	mA
Collector current	IC	_	_	10	mA
Operating temperature	T _{opr}	-25	_	85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.



Individual Electrical Characteristics (Ta = 25°C)

	Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
	Forward voltage	V_{F}	I _F = 10 mA	1.0	1.15	1.3	V
LED	Reverse current	I _R	V _R = 5 V	_	_	10	μA
	Capacitance	C _T	V = 0, f = 1 MHz	7	30	_	pF
	Collector–emitter breakdown voltage	V _(BR) CEO	I _C = 0.1 mA	350	/>	-	V
Detector	Emitter-collector breakdown voltage	V _(BR) ECO	I _E = 0.1 mA	77)_	_	V
Dete	Collector dark current	lono	V _{CE} = 300 V)	10	200	nA
	Conector dark current	ICEO	V _{CE} = 300 V, Ta = 85°C	_	_	50	μA
	Capacitance collector to emitter	C _{CE}	V = 0, f = 1 MHz	_	10	_	pF

Coupled Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min.	Тур.) Max.	Unit
Current transfer ratio	I _C / I _F	I _F = 5 mA, V _{CE} = 5 V Rank GB	50 100	\	600 600	%
Saturated CTR	I _C / I _F (sat)	IF = 1 mA, V _{CE} = 0.4 V Rank GB	30	60 —	_ _	%
Collector-emitter	4(I _C = 2,4 mA, I _F = 8 mA		_	0.4	
saturation voltage	V _{CE} (sat)	IC = 0.2 mA, IF = 1 mA	-	0.2	_	V
		Rank GB	-	_	0.4	

Isolation Characteristics (Ta = 25°C)

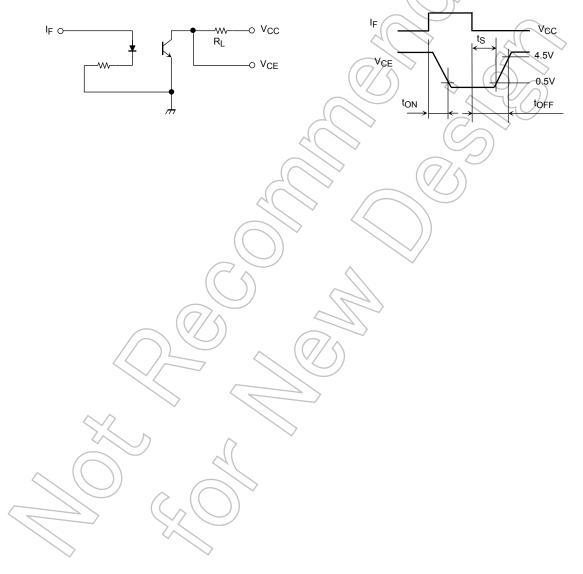
Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Capacitance input to output	Cs	V _S = 0, f = 1 MHz	_	0.8	_	pF
Isolation resistance	Rs	V _S = 500 V R.H. ≤ 60%	5×10 ¹⁰	10 ¹⁴	_	Ω
		AC, 1 minute	5000	_	_	V
Isolation voltage	BVs	AC, 1 second, in oil	_	10000	_	V _{rms}
		DC, 1 minute, in oil	_	10000	_	V _{dc}

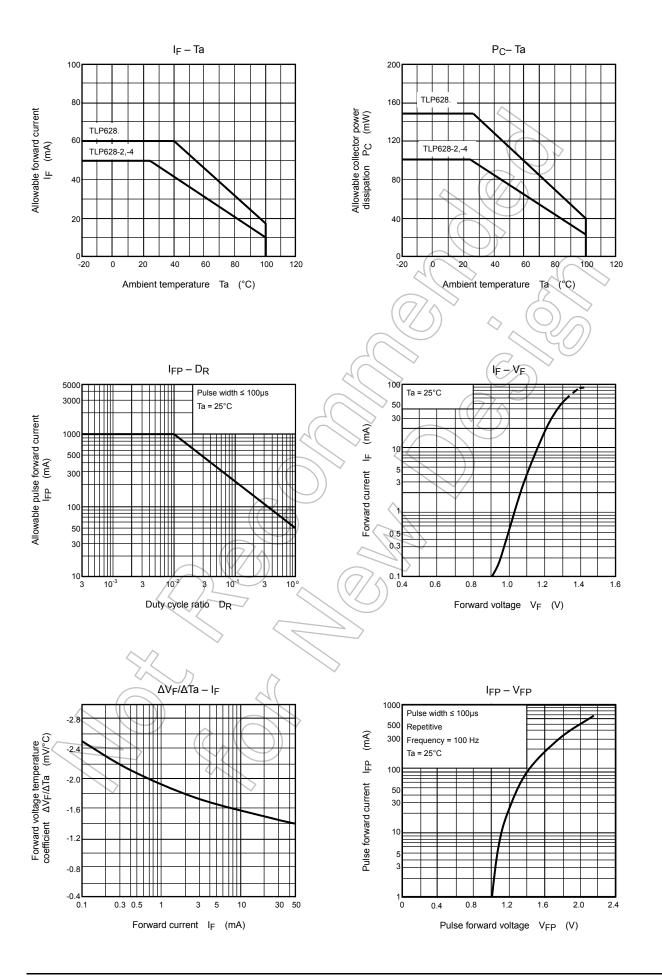


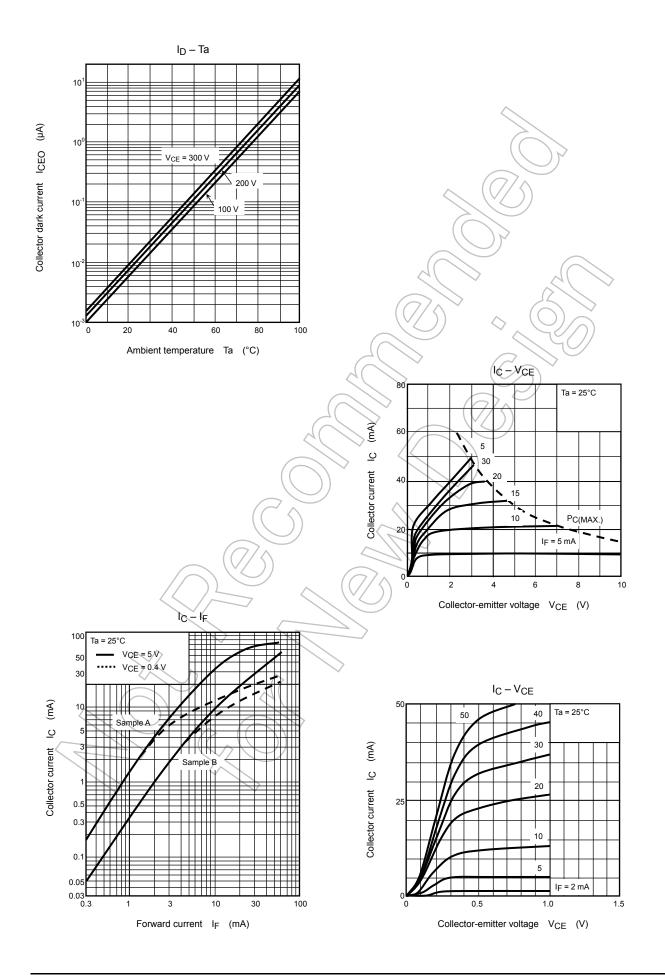
Switching Characteristics (Ta = 25°C)

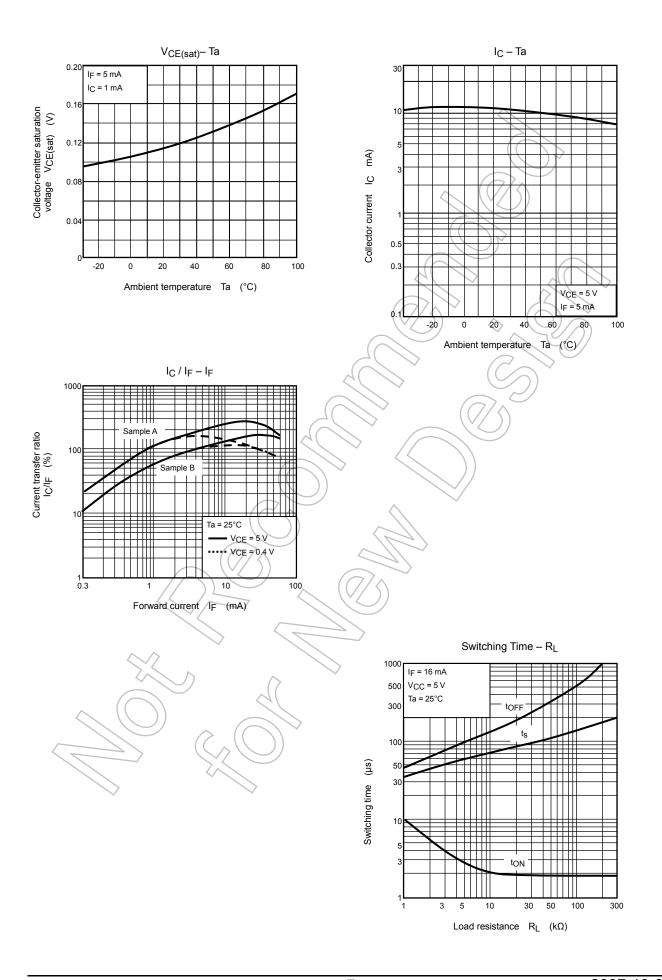
Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Rise time	t _r	$V_{CC} = 10 \text{ V, } I_{C} = 2 \text{ mA}$ $AR_{L} = 100\Omega$	_	2	_	
Fall time	t _f		_	3	_	116
Turn-on time	t _{on}		7	3	_	μs
Turn-off time	t _{off}			3	_	
Turn-on time	t _{ON}	$R_L = 1.9 \text{ k}\Omega \text{ (Fig.1)}$ $V_{CC} = 5 \text{ V, I}_F = 16 \text{ mA}$	1) /3	_	
Storage time	ts		7/_	40	_	μs
Turn-off time	t _{OFF}		\bigcirc	90	_	

Fig. 1 Switching time test circuit











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